

L Number	Hits	Search Text	DB	Time stamp
1	74	thermal\$3 adj cured adj epoxy	USPAT; EPO; JPO; DERWENT; USOCR	2003/11/07 08:59
2	42	(thermal\$3 adj cured adj epoxy) and substrate	USPAT; EPO; JPO; DERWENT; USOCR	2003/11/07 09:00
3	0	(thermal\$3 adj cured adj epoxy) and (latex adj base)	USPAT; EPO; JPO; DERWENT; USOCR	2003/11/07 09:00
4	10	(thermal\$3 adj cured adj epoxy) and latex	USPAT; EPO; JPO; DERWENT; USOCR	2003/11/07 09:00
5	10	((thermal\$3 adj cured adj epoxy) and latex) and substrate	USPAT; EPO; JPO; DERWENT; USOCR	2003/11/07 09:31
6	9	("4474685" "4883730" "5394304" "5696196" "5703761" "5918152" "5968600" "6046652" "6218610").PN.	USPAT	2003/11/07 09:06
7	3	("5160374" "5981043" "6110563").PN.	USPAT	2003/11/07 09:09
8	0	bisphenoal adj epoxies adj mixed adj amine	USPAT; EPO; JPO; DERWENT; USOCR	2003/11/07 09:32
9	0	bisphenoal adj epoxies	USPAT; EPO; JPO; DERWENT; USOCR	2003/11/07 09:32
10	0	bisphenol adj epoxies adj mixed adj amine	USPAT; EPO; JPO; DERWENT; USOCR	2003/11/07 09:32
11	17	bisphenol adj epoxies	USPAT; EPO; JPO; DERWENT; USOCR	2003/11/07 10:16
13	0	(bisphenol adj epoxies) and (amine adj hard\$3)	USPAT; EPO; JPO; DERWENT; USOCR	2003/11/07 10:16
12	8	(bisphenol adj epoxies) and amine	USPAT; EPO; JPO; DERWENT; USOCR	2003/11/07 10:19
14	0	comformal adj EMI adj coating	USPAT; EPO; JPO; DERWENT; USOCR	2003/11/07 10:20
15	1	comformal adj coating	USPAT; EPO; JPO; DERWENT; USOCR	2003/11/07 10:20